

SHIGA7.050APC

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Takahashi et al.
Appl. No. : U.S. National Phase of
PCT/JP2004/017533
Filed : Herewith
For : CHEMICALLY AMPLIFIED
POSITIVE PHOTSENSITIVE
THERMOSETTING RESIN
COMPOSITION, METHOD OF
FORMING CURED ARTICLE,
AND METHOD OF PRODUCING
FUNCTIONAL DEVICE
Examiner : Unassigned
Group Art Unit : Unknown

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

May 22, 2006

(Date)

Neil S. Bartfeld, Ph.D., Reg. No. 39,901

PRELIMINARY AMENDMENT**Mail Stop PCT**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Prior to examination of the above-referenced application, please enter the following amendments:

Amendments to the Specification begin on page 2 of this paper.

Remarks begin on page 3 of this paper.